

ESB Mechanical

Progress Report

Z. Papandreou
BIC Workshop
June 16, 2026

ESB Napkin Sketch - Electron End

Legend:

PbScFi

CALOROC

Astropix

ETC

Light Guides

ETC cable

Cookies

Top plate

SiPMs

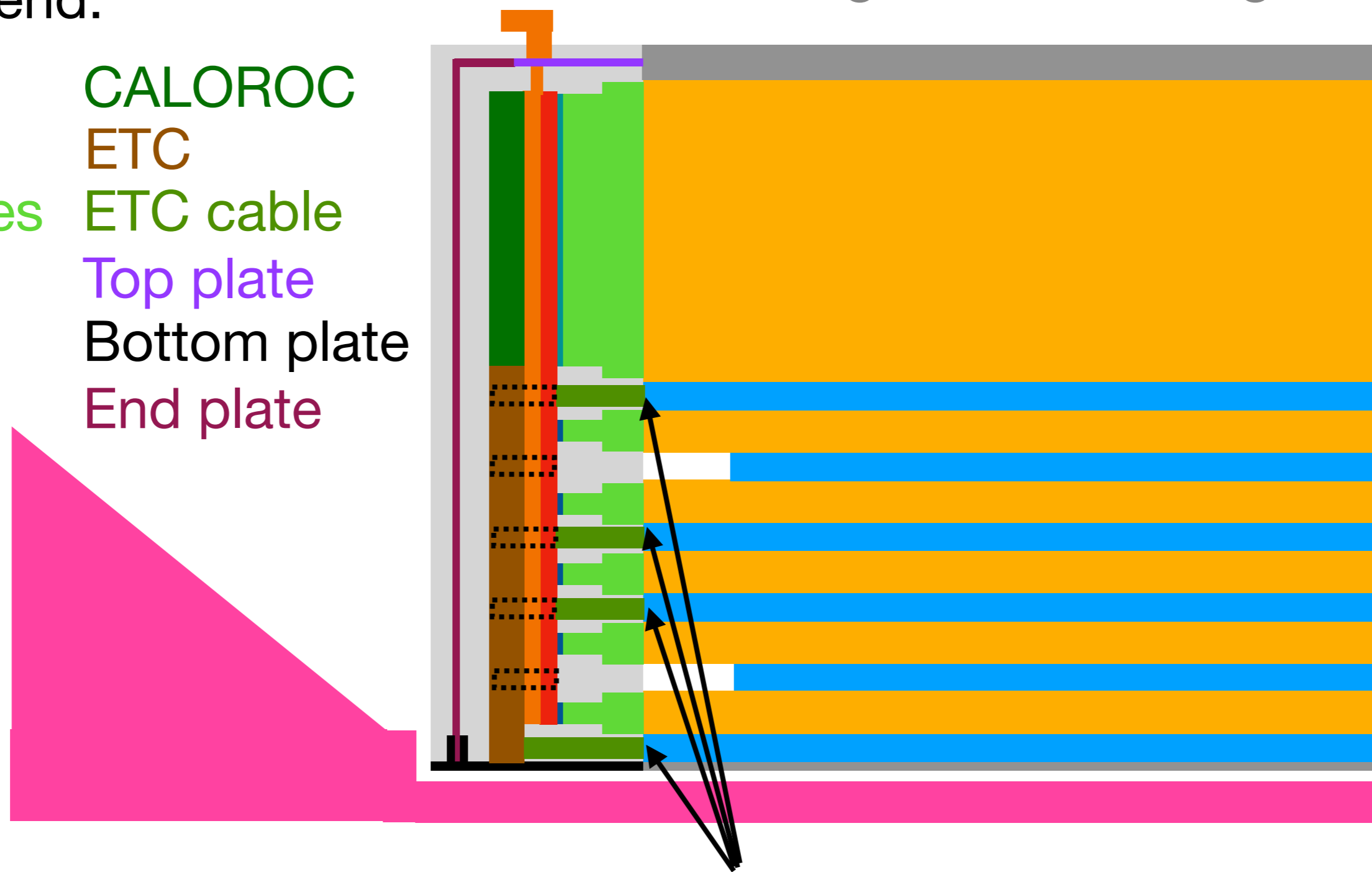
Bottom plate

Cooling

End plate

(Nasty)
DIRC

Challenge in servicing



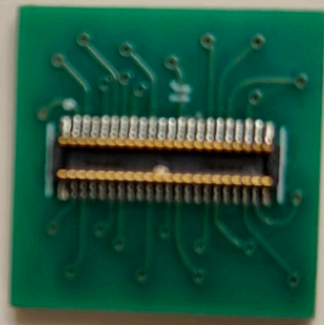
ETC to Astropix connector

ETC window thru SiPM/Cooling layers

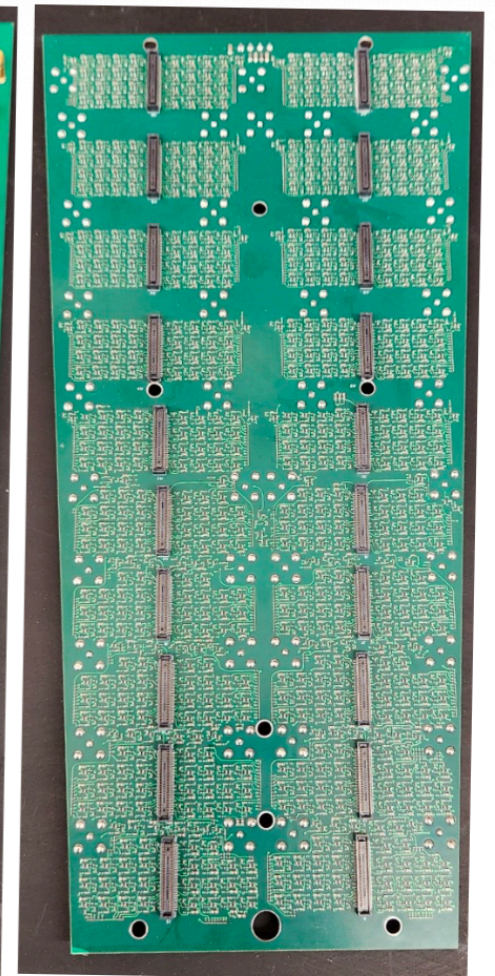
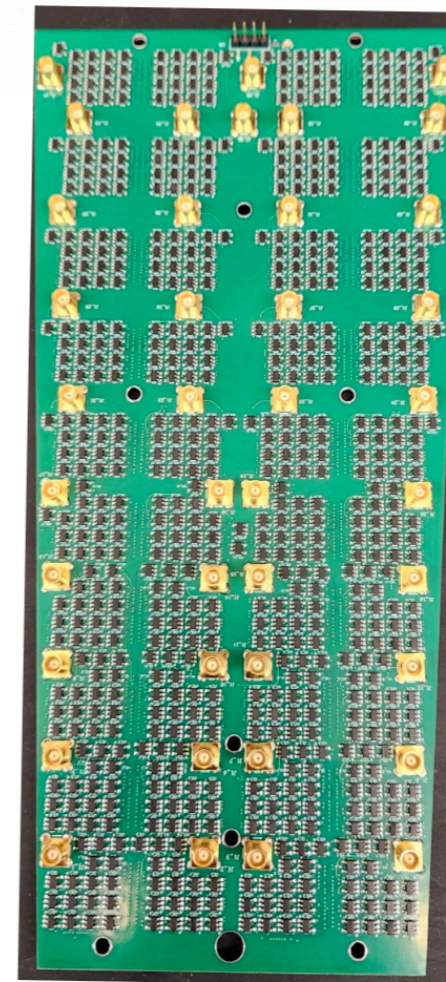
Baby BCAL Box - Goals

- Mechanical interface to Baby BCAL
- Design v1 exists: no side panels
- August at Hall D / JLab:
 - Keep BCAL light guides
 - New Amp / Sum Uni-boards (easier to cool)
 - Connection / interface to HGCROC
 - Air cooling
 - Discuss needs for Rapid Access to Hall D

Baby BCAL readout based on 16 channel readout



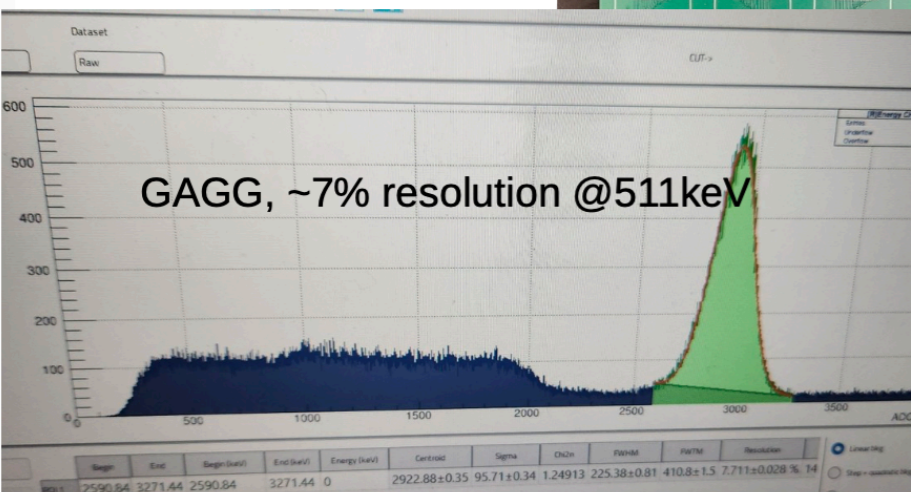
Mini-board



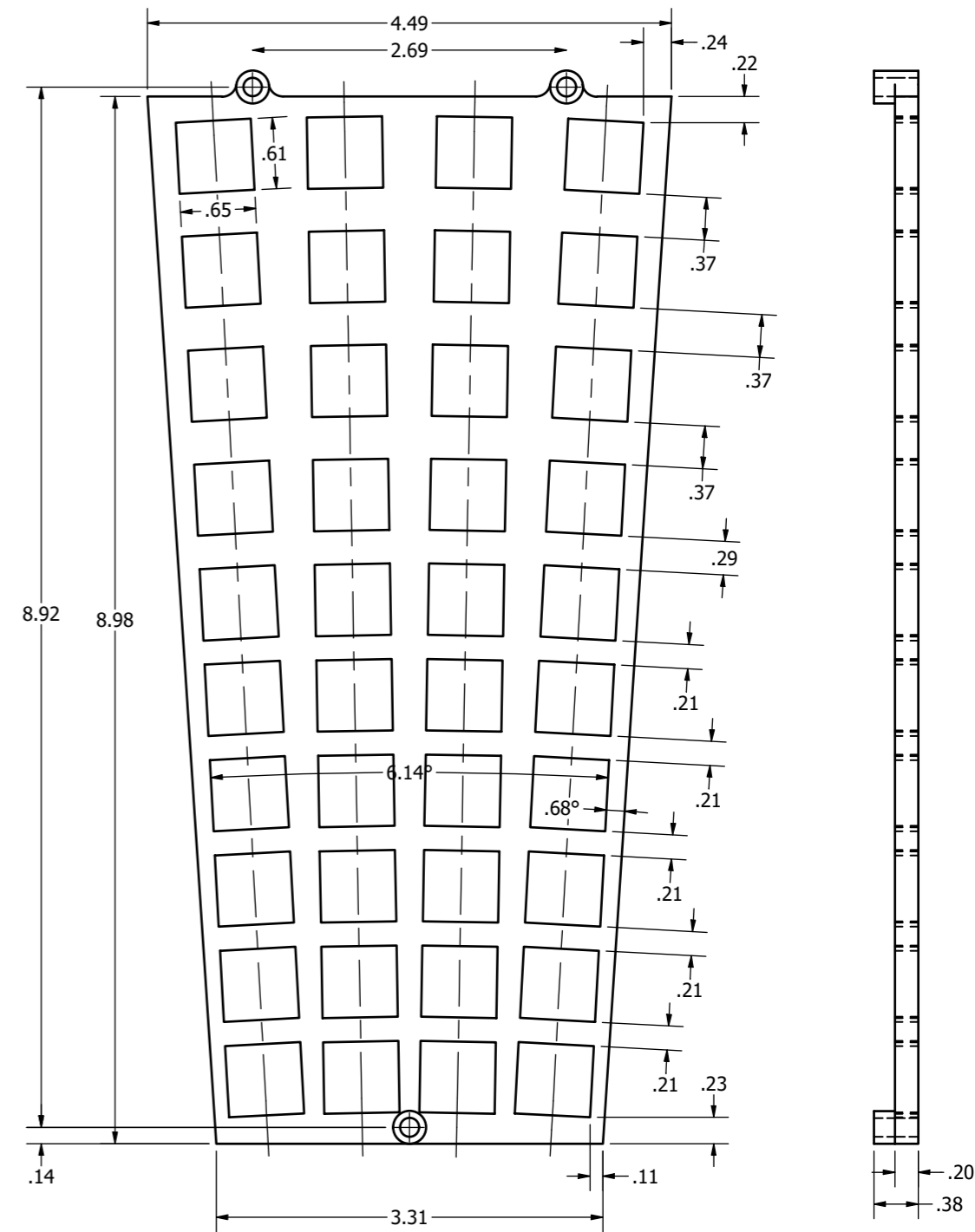
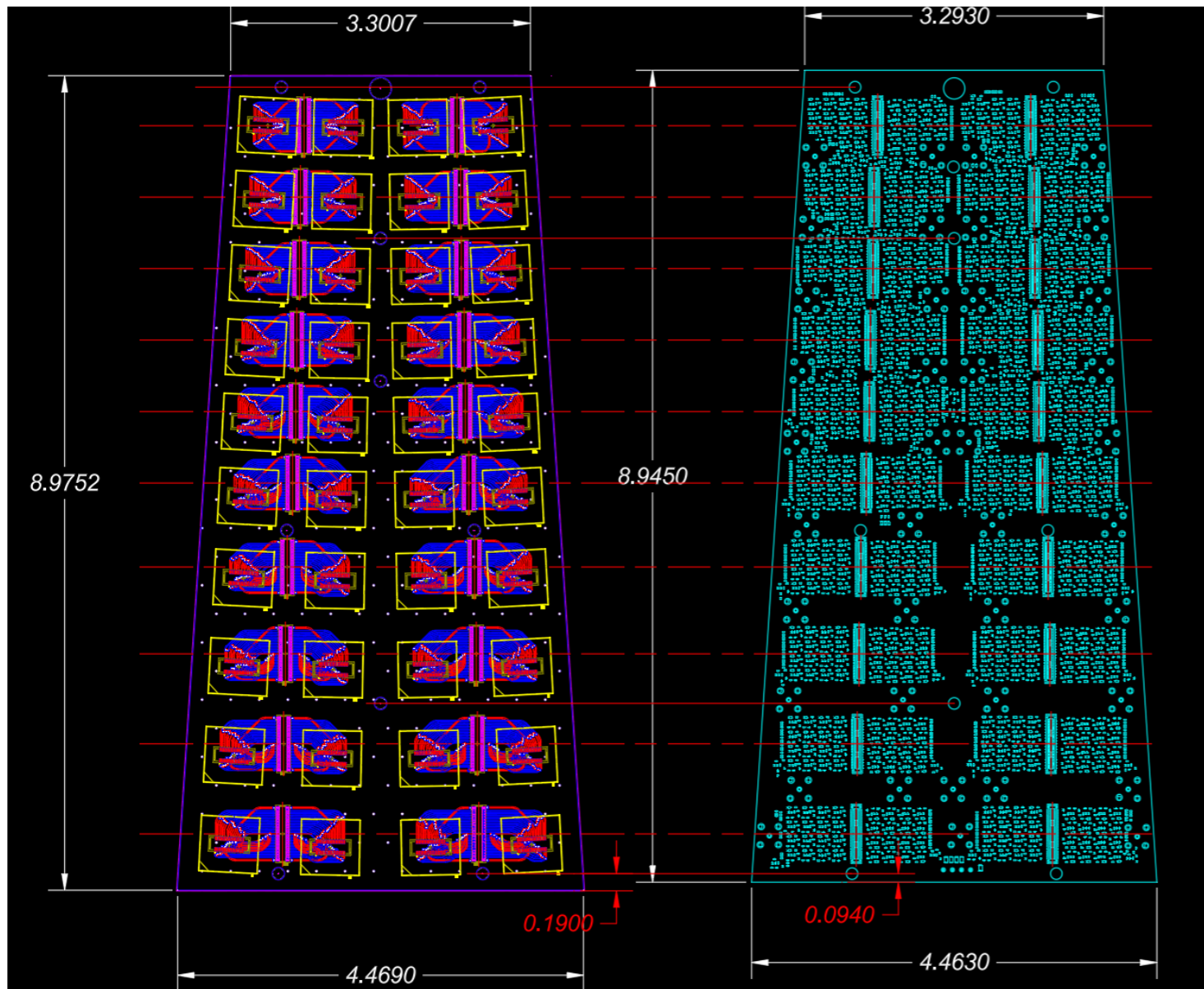
Amplifier board for 40 sipm arrays
16 channels each.

Only ~8W! For entire board

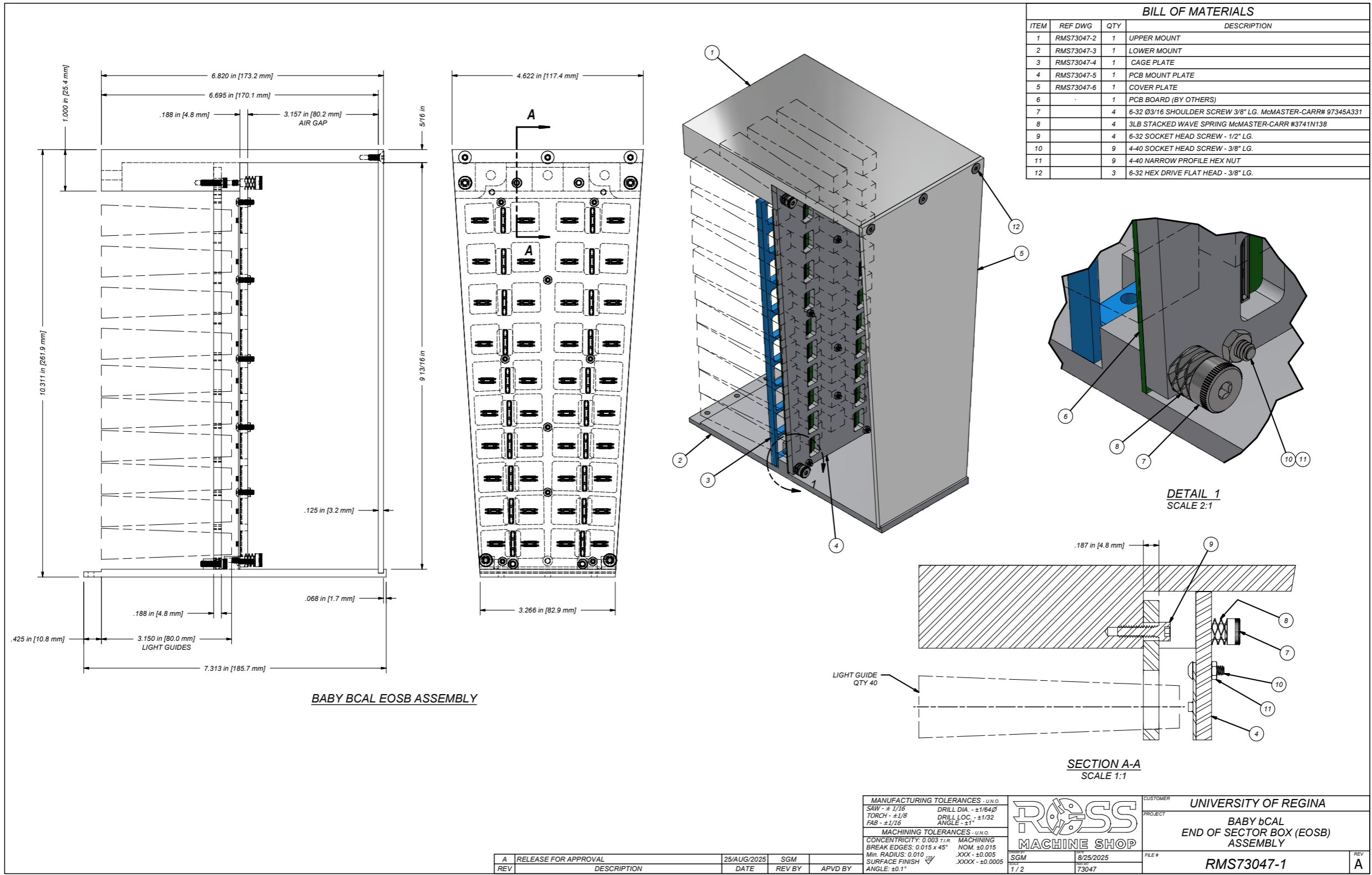
GAGG, ~7% resolution @511keV



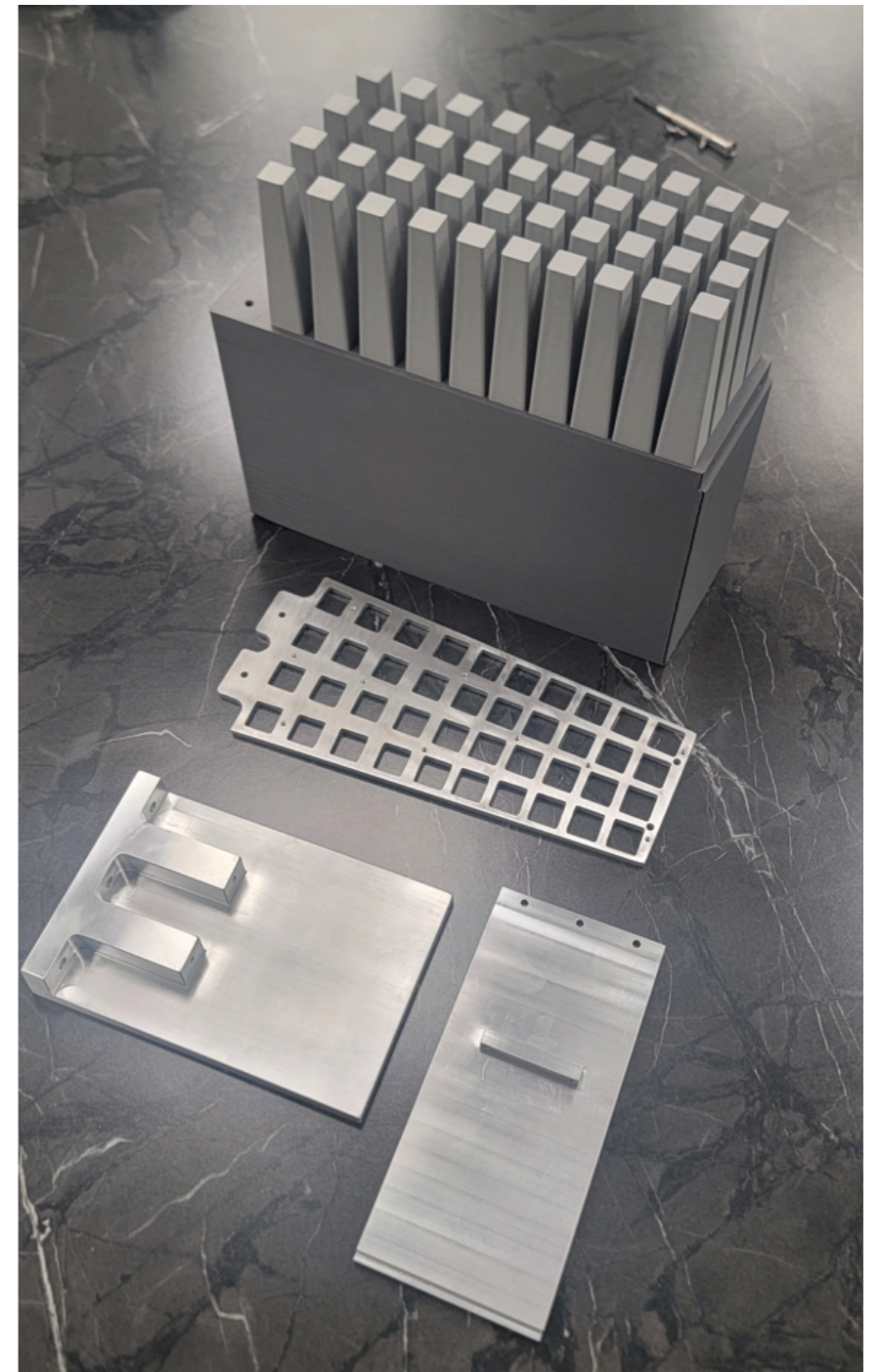
Baby BCAL Box - Design & 3D-print mockup



Baby BCAL Box - Design & 3D-print mockup



Baby BCAL Box - Design & 3D-print mockup



BIC Light Guides

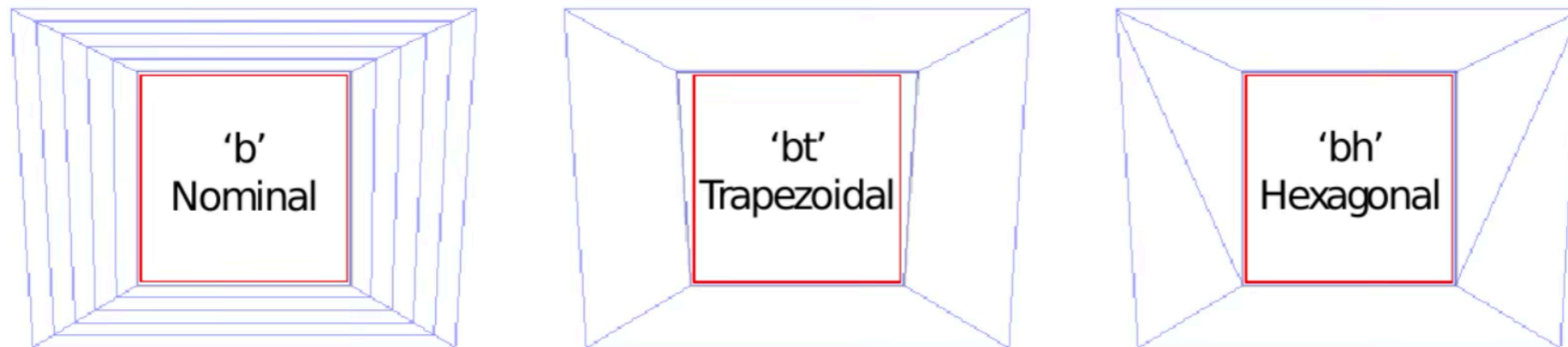


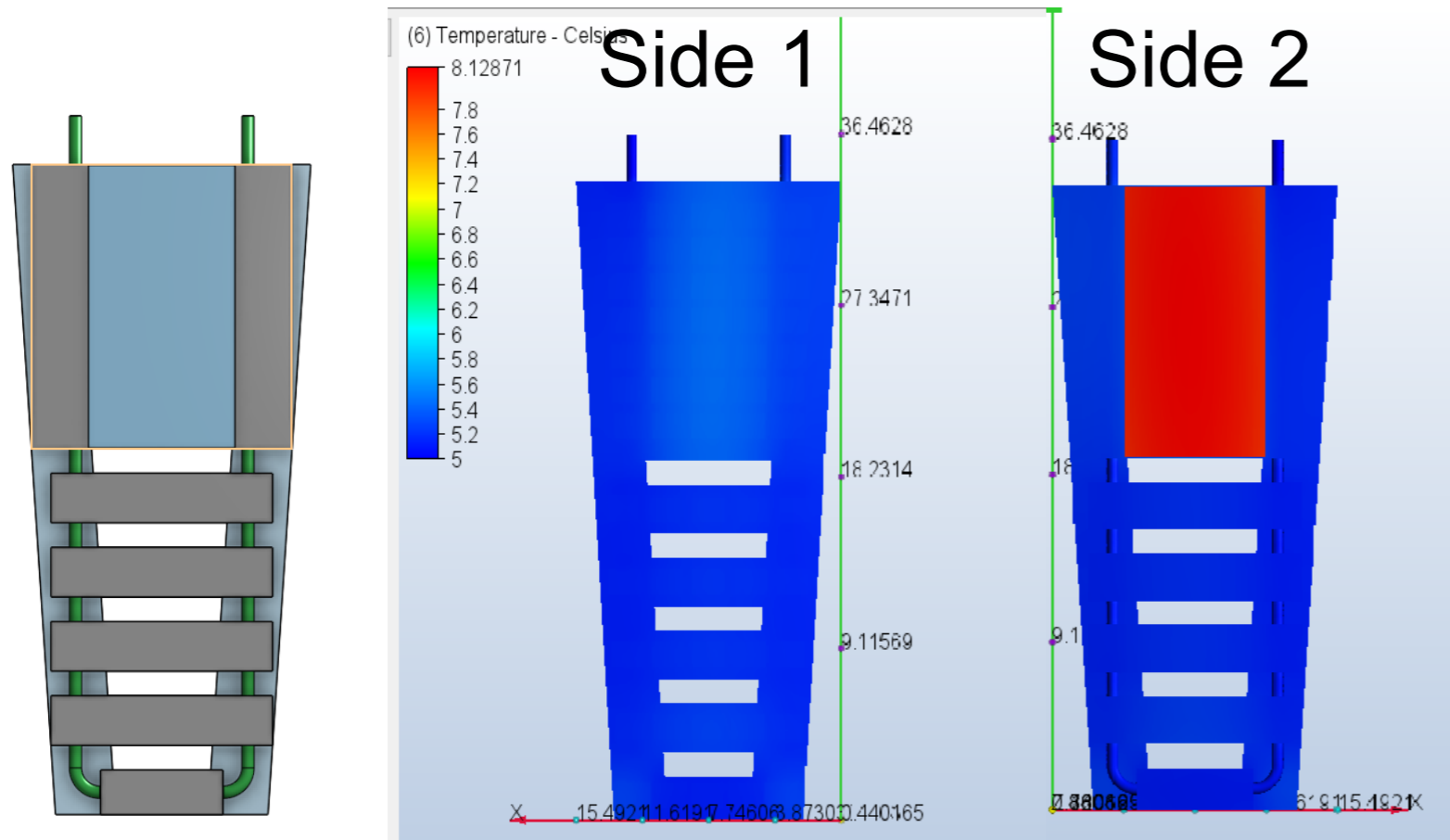
Figure 3: Geant4 renders of the Nominal ('b'), trapezoidal ('bt'), and hexagonal ('bh') BIC light guide shapes. The active SiPM area is shown in red.

Some shipped to KNU; rest under test right now with 16-channel SiPM array

- A) 50-mm-long light guides: 2 OF EACH KIND
 - 1) all three designs, b1_50, bh1_50, bt1_50 drawings (1st layer)
 - 2) all three designs, b12_50, bh12_50, bt12_50 drawings (12th layer)
- B) 60-mm-long light guides: 2 OF EACH KIND
 - 3) only the nominal design, b12_60 drawing (12th layer)

Cooling R&D

- Thermal simulation at Manitoba Univ.



- Prototype at KNU



Aluminum cold plate, PCBs on both sides:

- Side 1: ESB PCB with SiPMs
- Side 2: CALOROC and AstroPix ETC

Design dimensions:

- Cu cooling lines $\frac{1}{4}$ " OD
- Aluminum cold plate thickness $\frac{1}{2}$ "

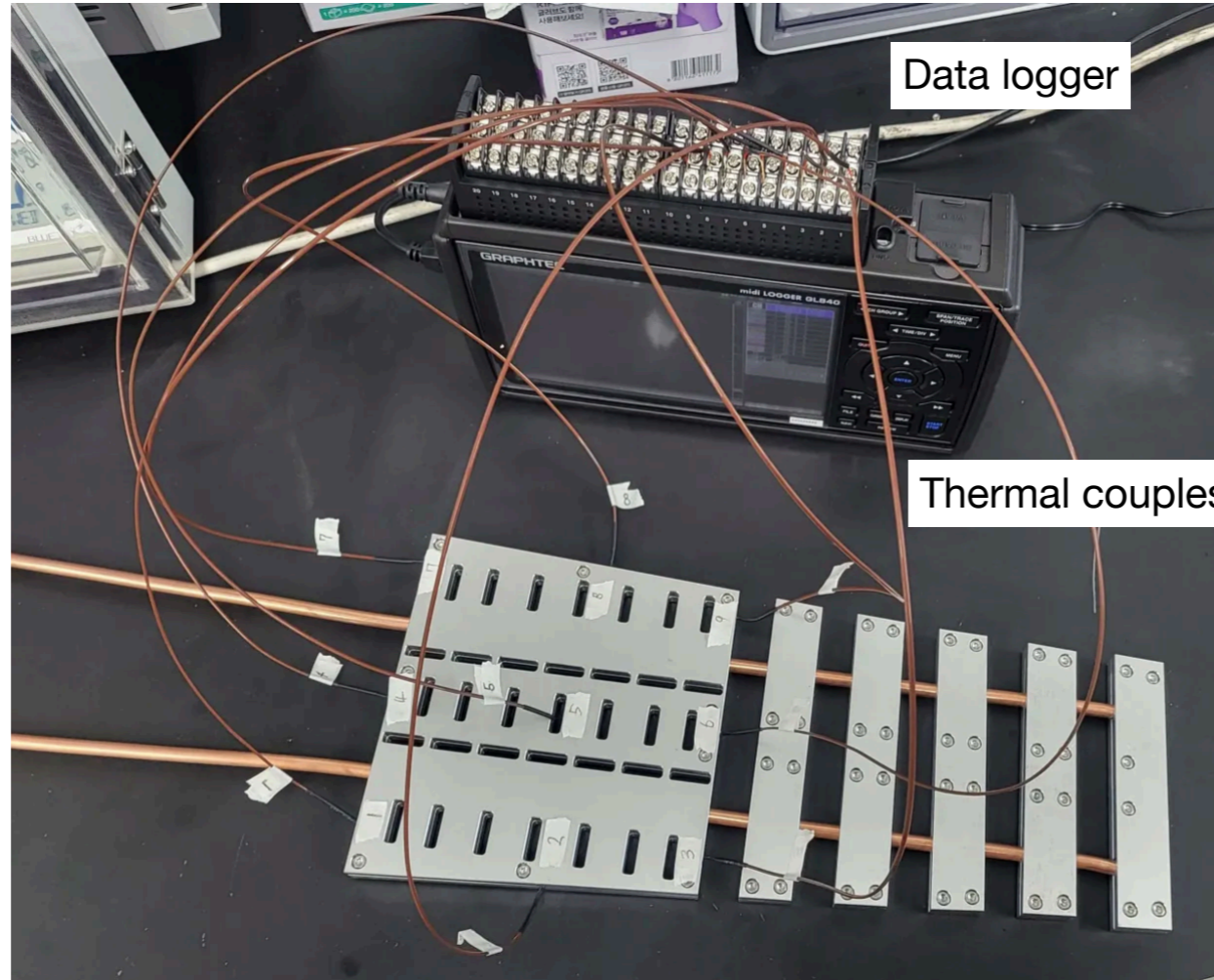
Cooling R&D

Goal: Temp/Gain Stabilize SiPMs;
Use passive circuit (copy BCAL)

- Water cooling
- Temperature monitoring
- Prototype at KNU

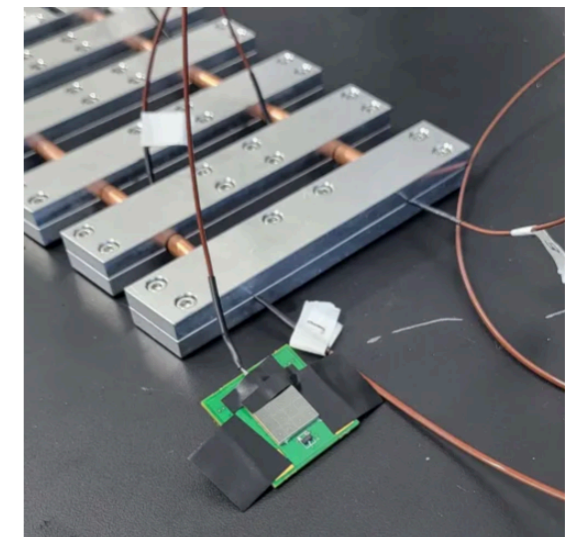


Chiller (7 °C , 1.1 L/min)



Data logger

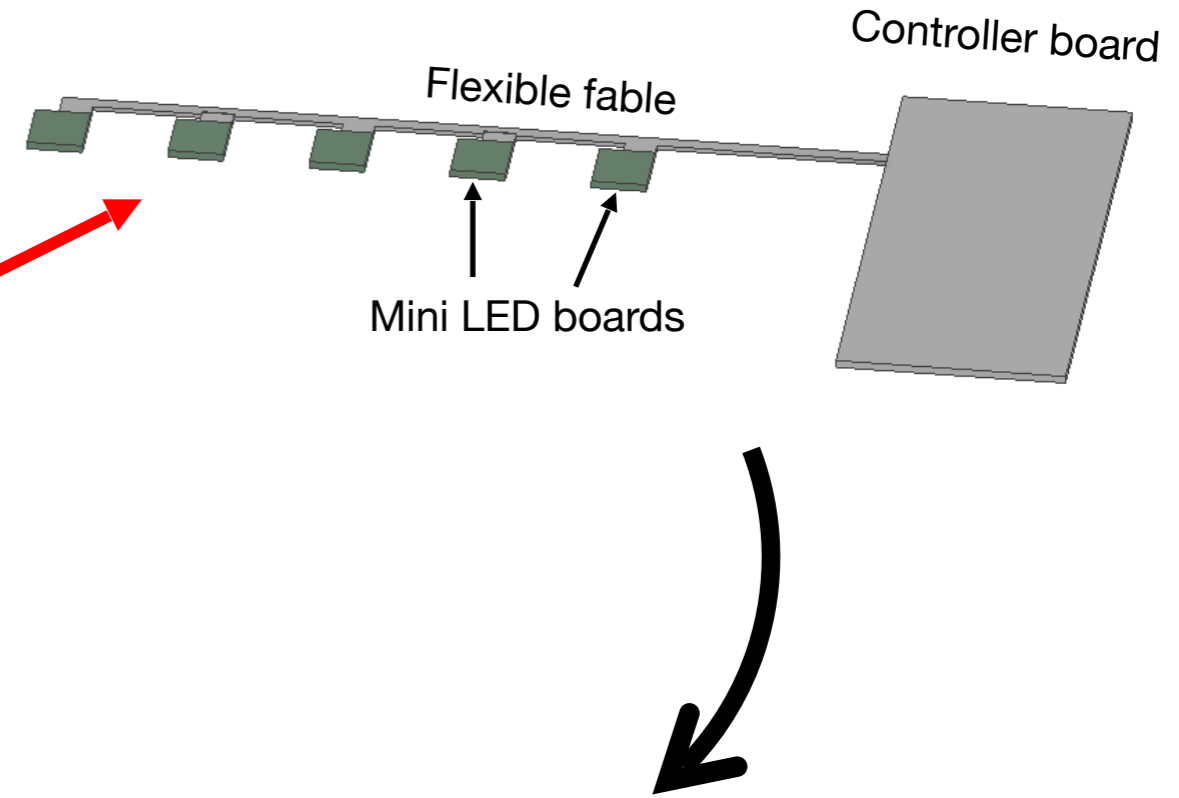
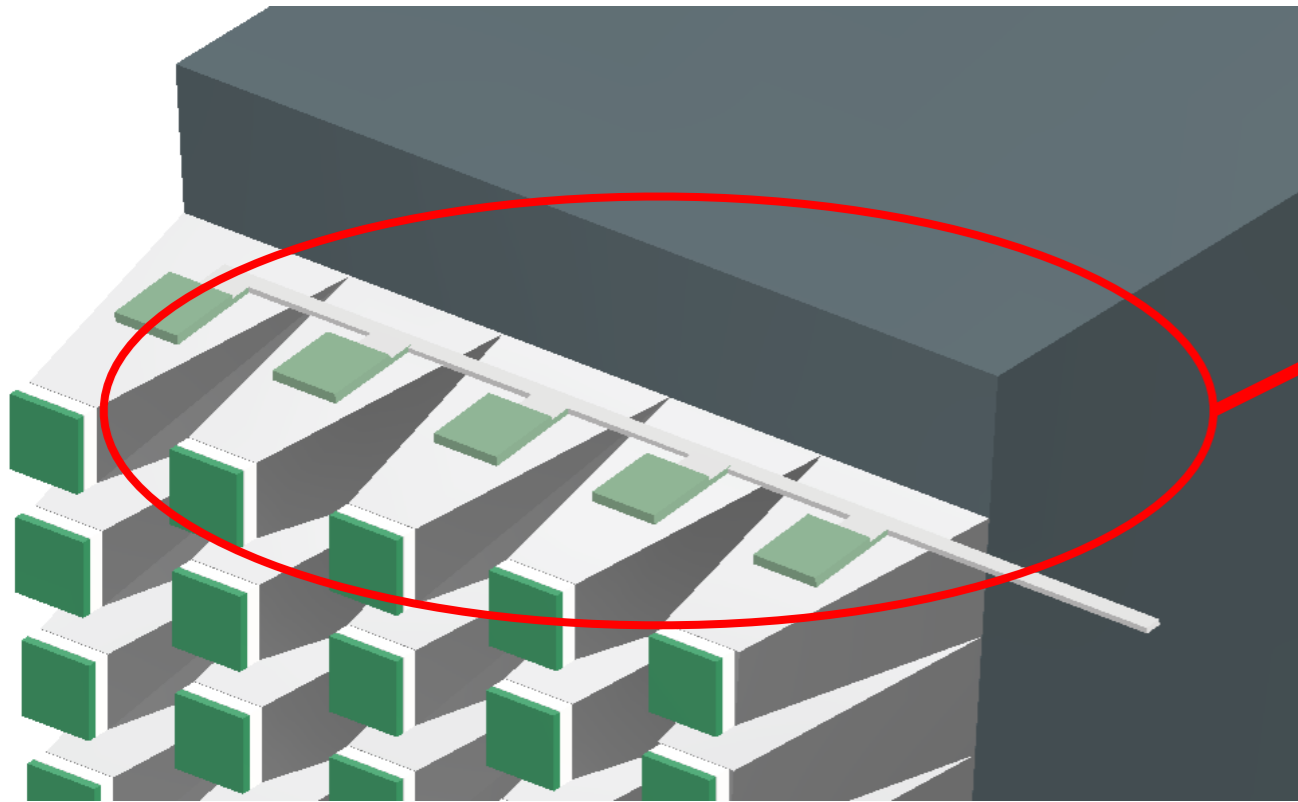
Thermal couples



- Water temperature: -25 ~ 150 °C
- flow rate: 0.006 ~ 3400 mL/min

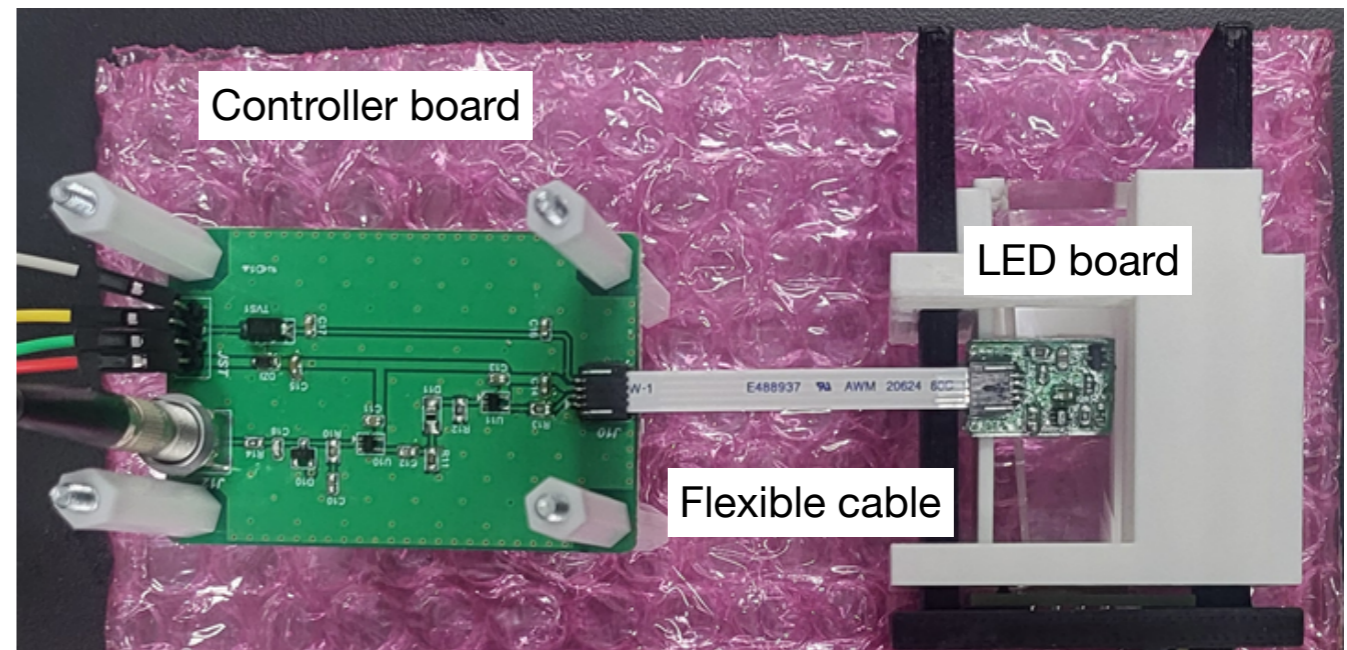
- Ongoing: development and construction of PCB (thermal) test articles for validation of CFD calculations
 - resistive element array distributed at locations of SiPMs

LMS system



- glueX LMS system

- 1-ch prototype board at KNU

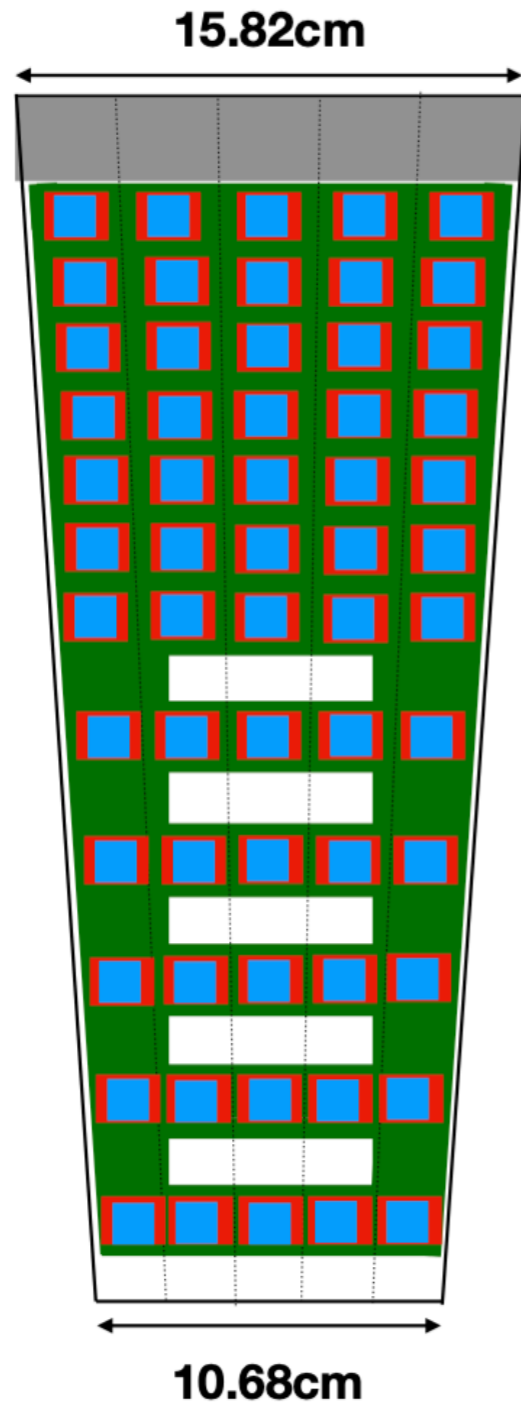


- Test on-going

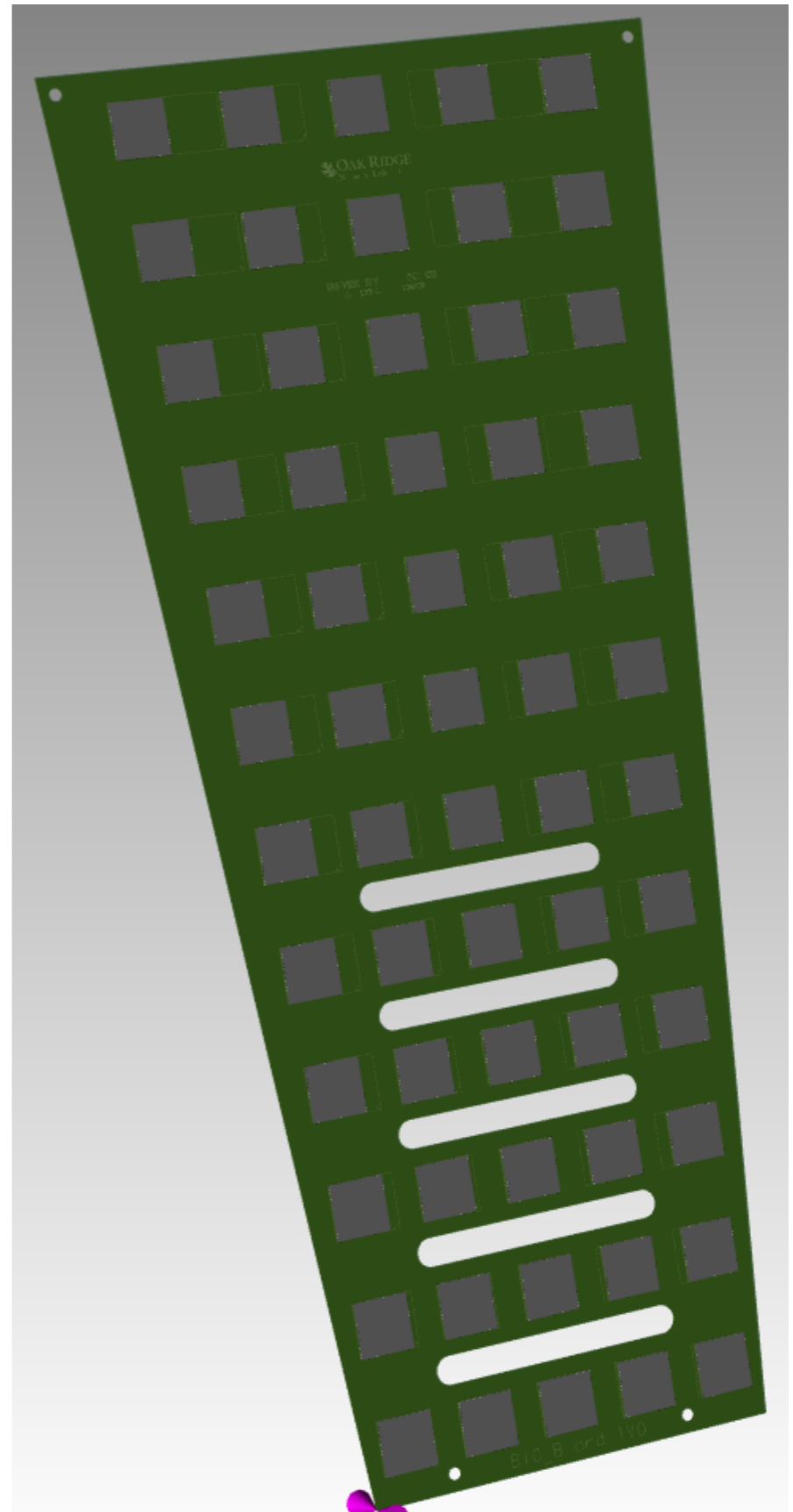
Summary & Looking Ahead

- Mechanical:
 - Baby BCAL box - design advanced for August 2026 at Hall D; air cooling, new amp/sum boards, signals suitable for HGCROC
 - BIC Box - design in September-October
 - LGs 50mm design being tested; *see Thursday Open Contributions*
 - Cooling design advanced; *see next talk*
 - LMS underway; *see Thursday Open Contributions*
- Electronics:
 - *See other sessions today and tomorrow.*

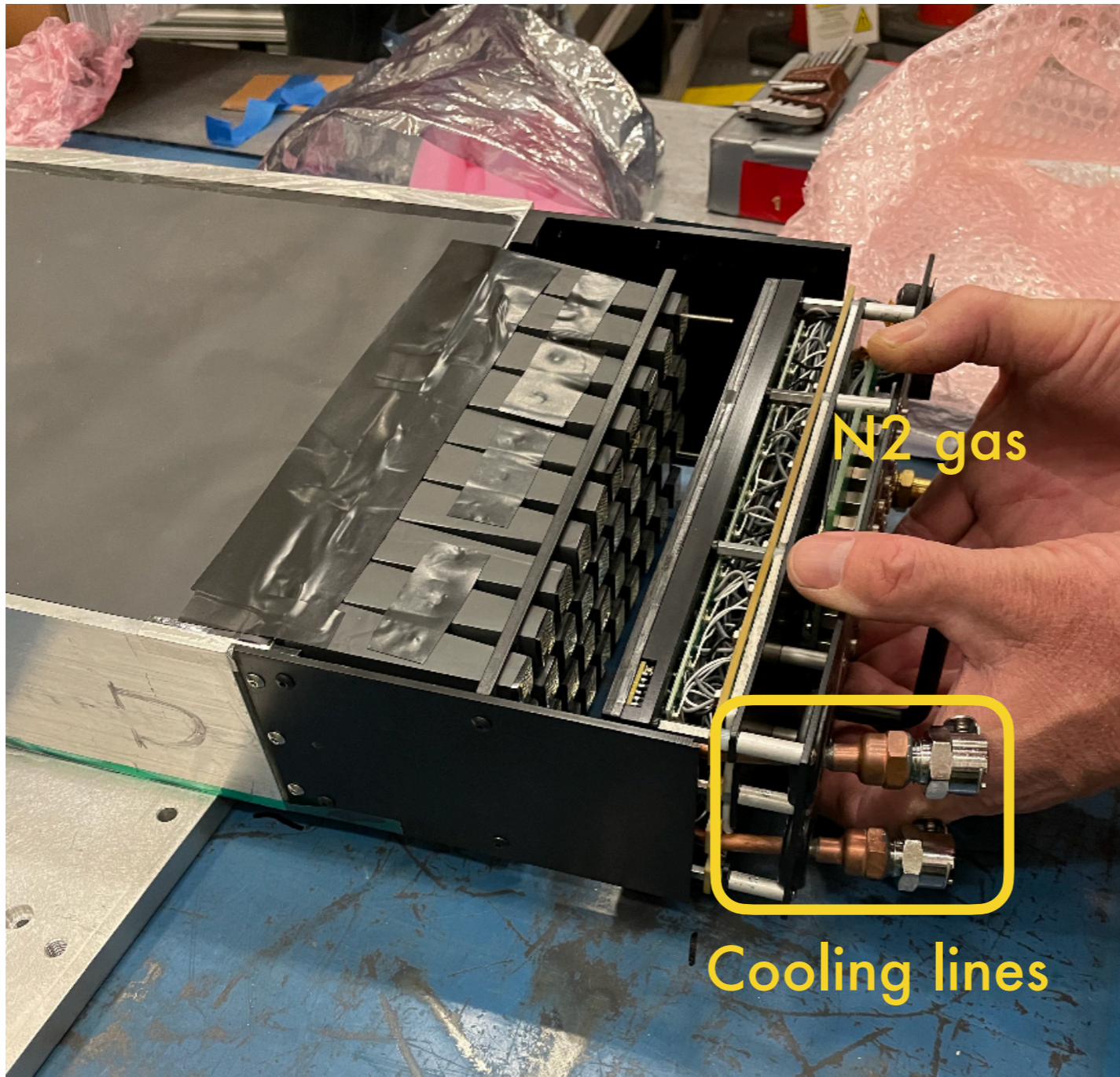
Backup slides



Testing at ORNL



BCAL "Wedges"



- Contiguous LG stacking
- LG-SiPM air gap
- BIC: Si cookie
- Spring loading
- Integrated ESB for installation ease